Unictron

Product Name: WiFi/Bluetooth Chip Antenna – CW201

Part Number: H2U34C1H1B0100

Features:

- Supporting WiFi/Bluetooth, covering 2400 to 2484 MHz
- Surface Mount
- Dimensions: 2.0 x 1.2 x 0.6 mm
- High performance, small size.
- RoHS & REACH & HF Compliant
- AEC-Q200 Compliant

Applications:

- ISM 2.4 GHz applications
- ZigBee/BLE applications
- Bluetooth earphone systems
- Hand-held devices when WiFi / Bluetooth functions are needed, e.g., Smart phones
- IEEE802.11 b/g/n

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WiFi/Bluetooth Chip Antenna

MODEL: CW201

Version: H

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I. Specifications:

Items	Specifications
Frequencies (MHz)	2400~2484
Return loss (dB)	< -10 Typ.
Efficiency (%)	62 Typ.
Average Gain (dB)	-2.1 Typ.
Peak Gain (dBi)	2.1 Typ.
Test Condition	40 x 20 mm² (Evaluation board)
Impedance (Ω)	50
Polarization	Linear Polarization

Mechanical Specifications	
Dimensions (mm)	2.0(L) x 1.2 (W) x 0.6 (H)
Material	Ceramic
Termination	Ag (environmental Pb free)
Environmental Conditions	
Operation Temperature (°C)	-40 ~ +85
Storage Temperature (°C)	-5 ~ +40
Relative Humidity	10 ~ 70 %

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II. Layout Guide:

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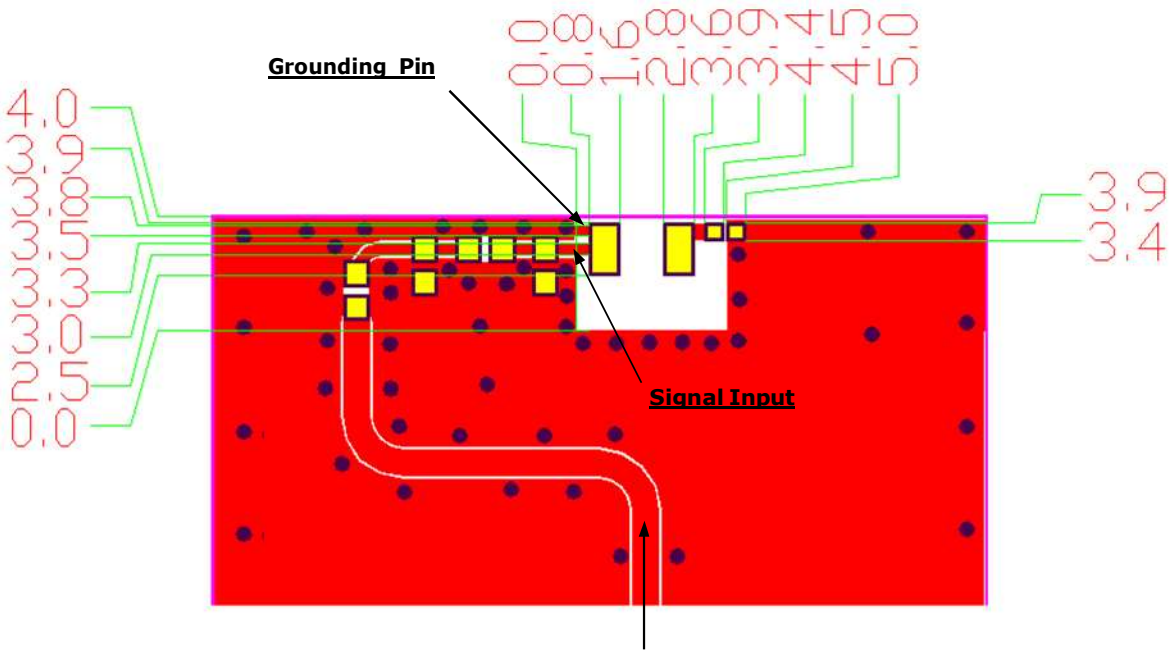
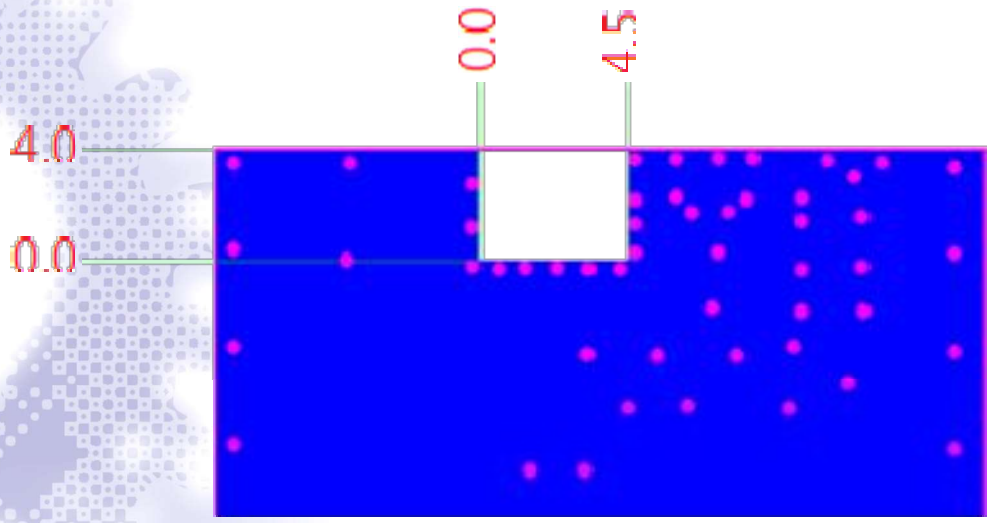
Solder Land Pattern:

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.

Top View



Bottom View



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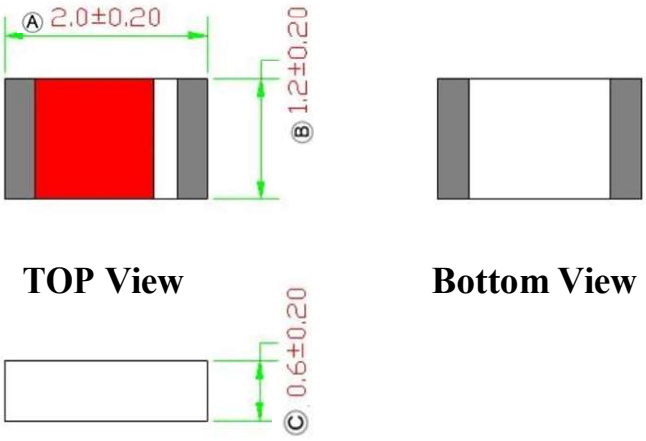
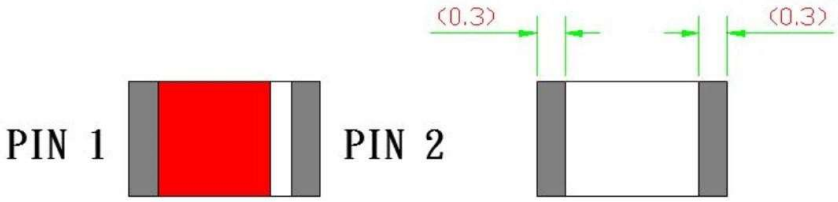
III. Mechanical Dimensions:

a) Antenna Dimensions



Unit: mm

b) PIN Definition



Unit: mm

PIN	1	2
Soldering Pad	Signal Input	Tuning/Signal Output

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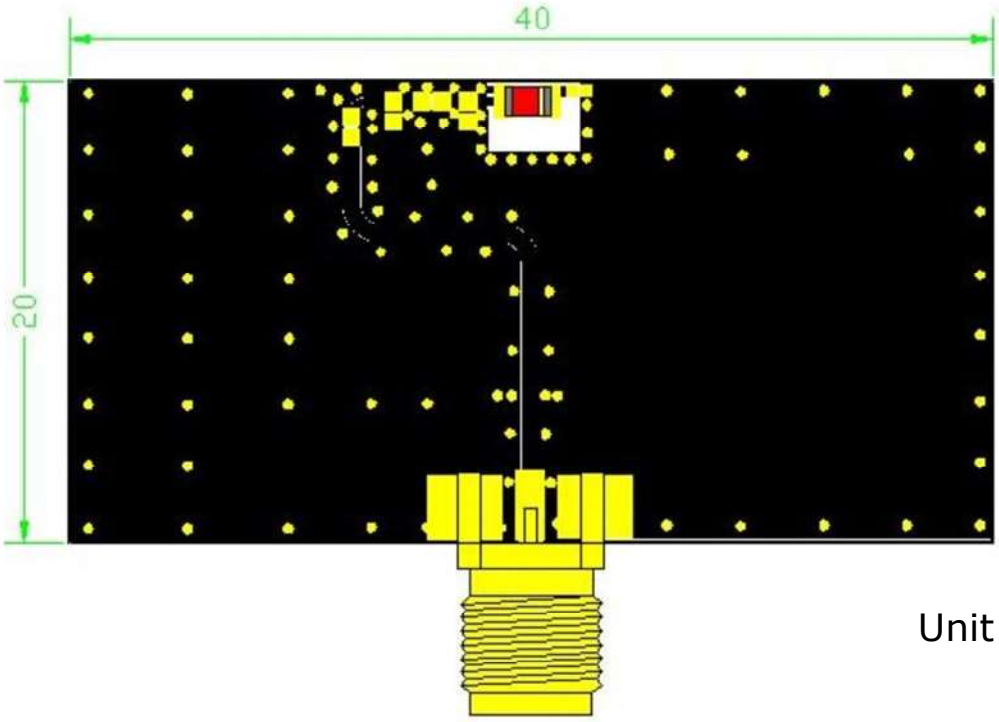
c) Test Board with Antenna



Unit: mm

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IV. Properties:

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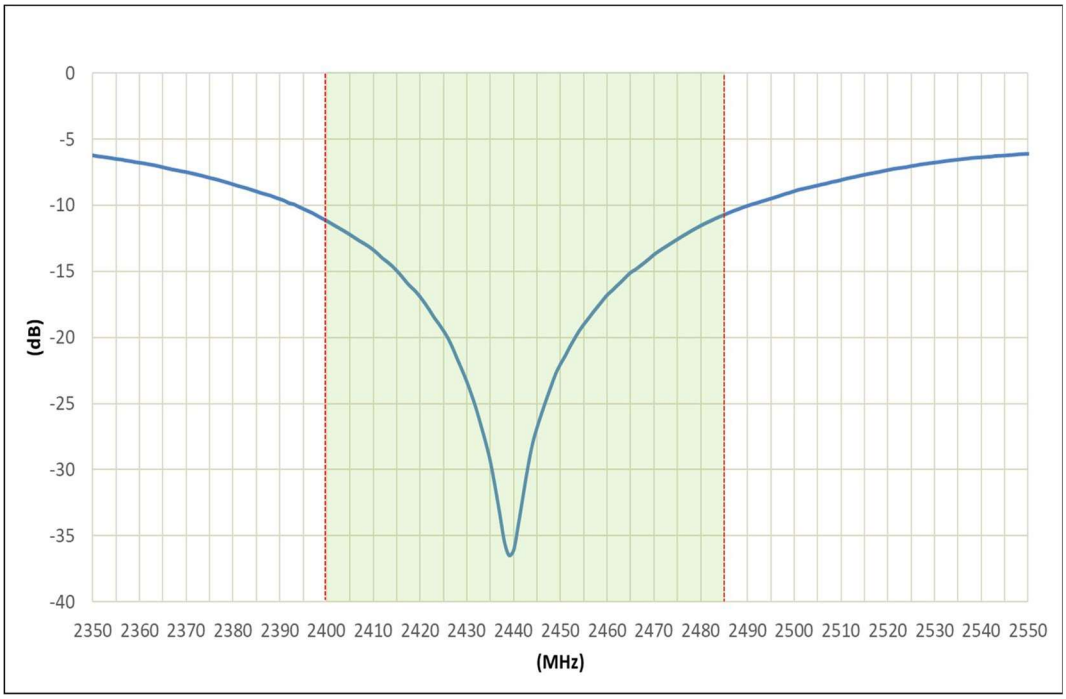
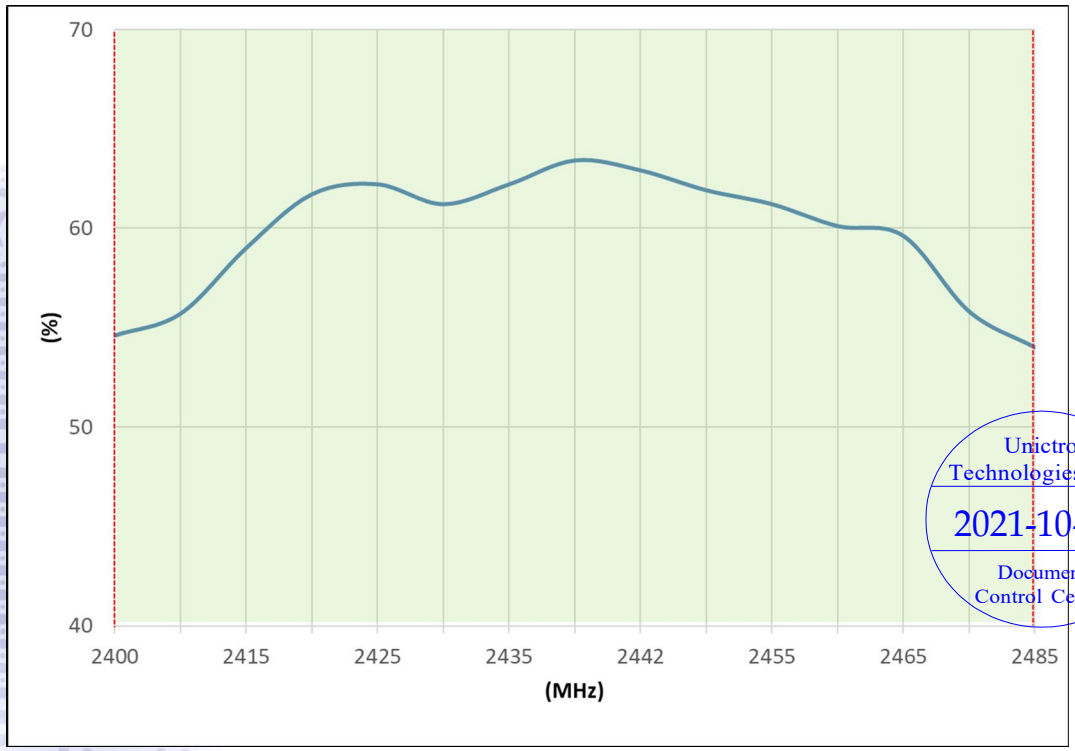
a) Return loss (dB)



b) Efficiency (%)



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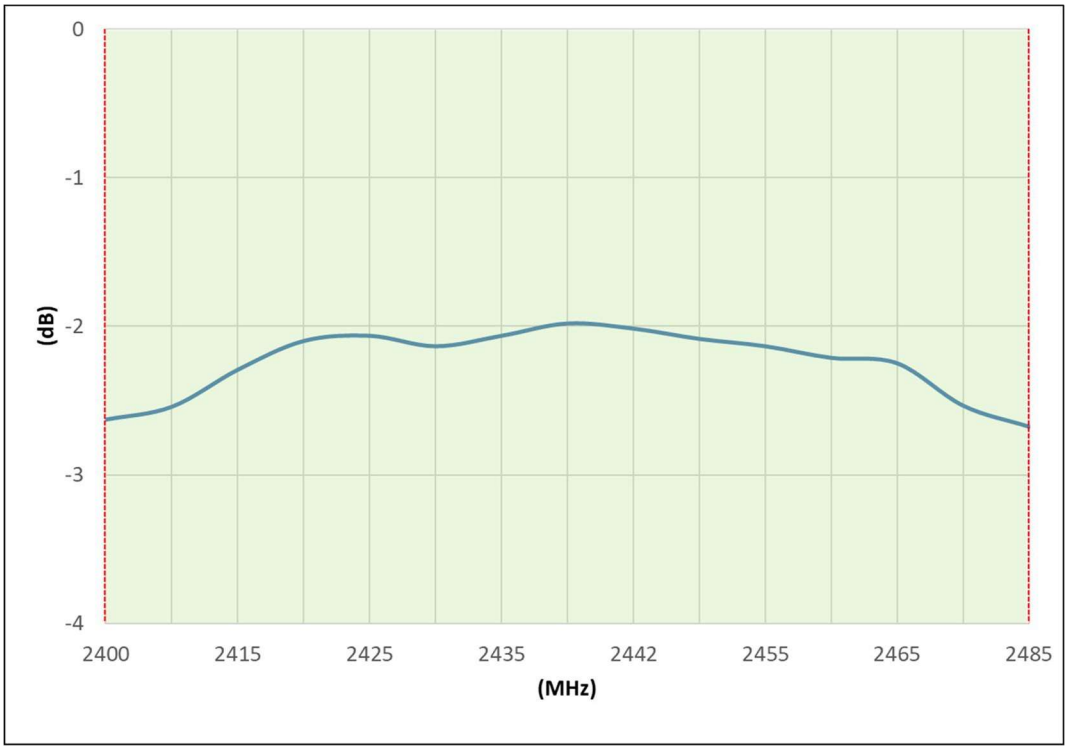
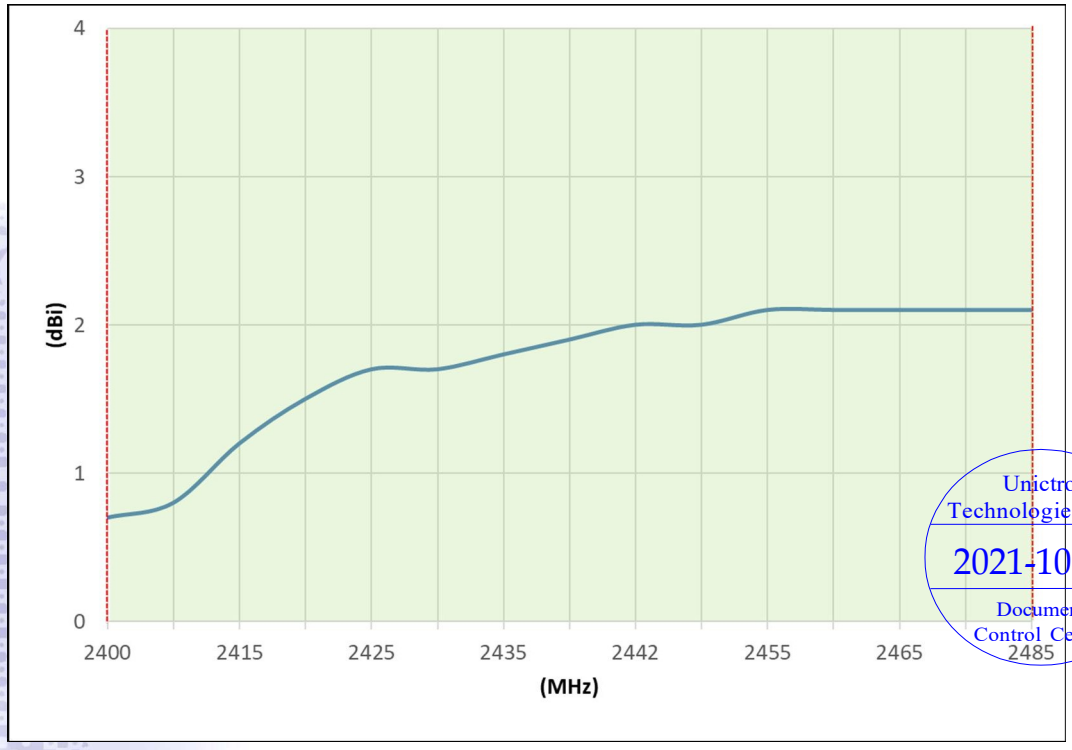
c) Average Gain (dB)



d) Peak Gain (dBi)



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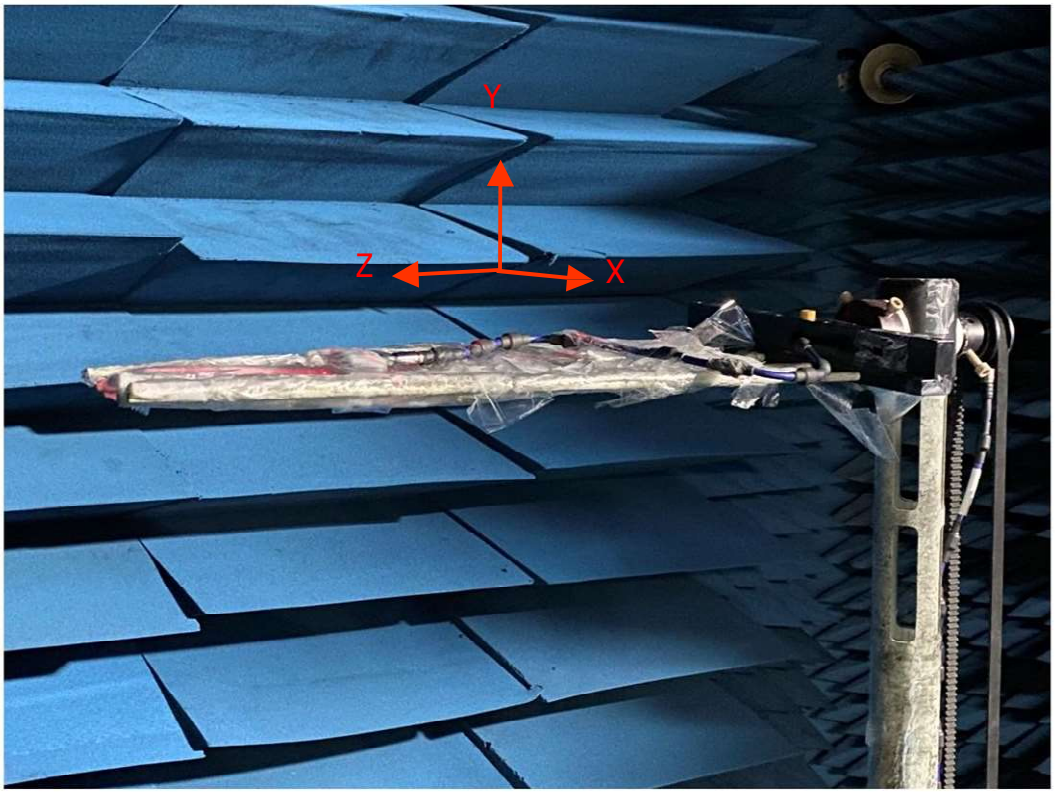
V. Antenna Radiation Pattern Measurement:

The antenna radiation patterns are measured in Unictron's 3D Anechoic Chamber. The measurement setup is as show below.



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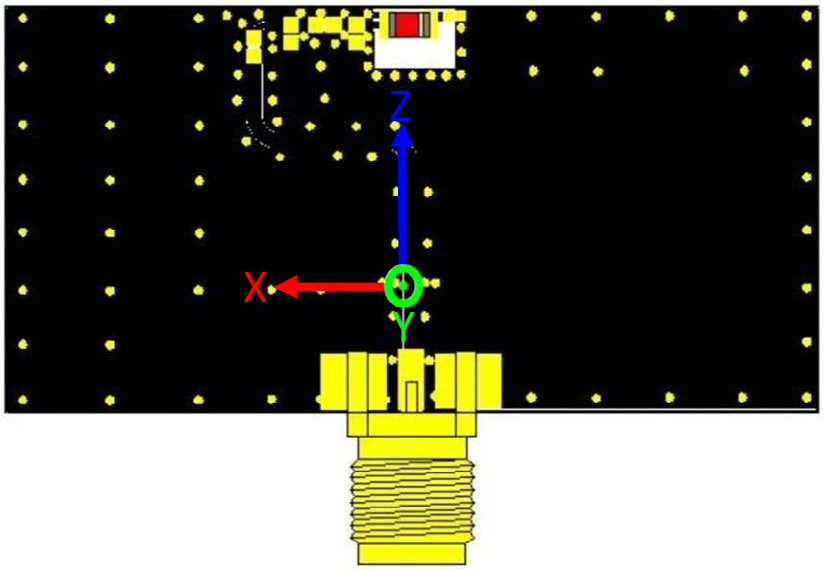
3D Radiation Gain Pattern



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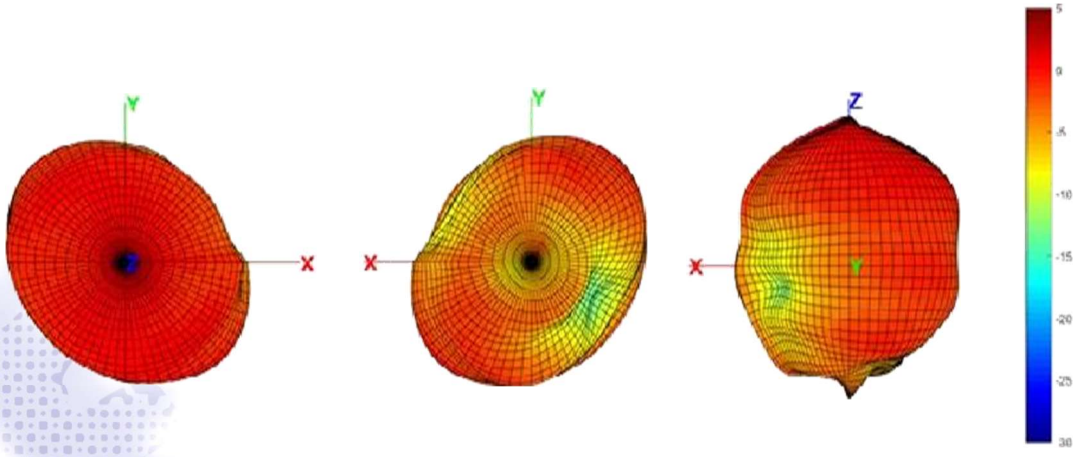
2450 MHz (unit: dBi)



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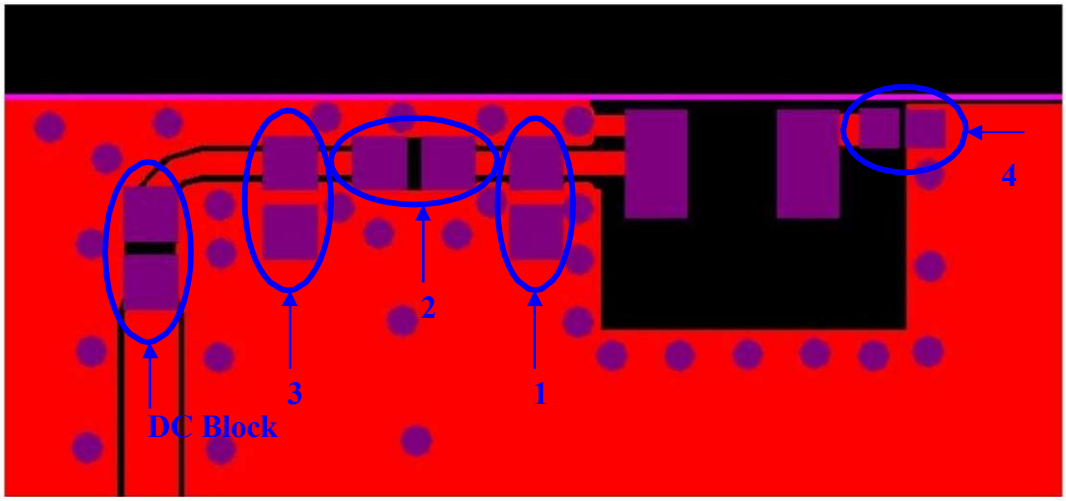
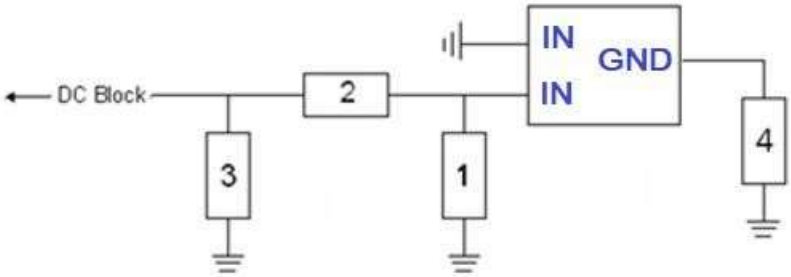
VI. Frequency tuning:





System Matching Circuit Component			
Location	Description	Vendor	Tolerance
1	N/C	-	-
2	5.0 pF (0402)	MURATA	±0.05 pF
3	0.8 pF (0402)	MURATA	±0.05 pF
4	2.7 pF (0201)	MURATA	±0.05 pF
DC Block	22 pF (0402)	MURATA	±5%

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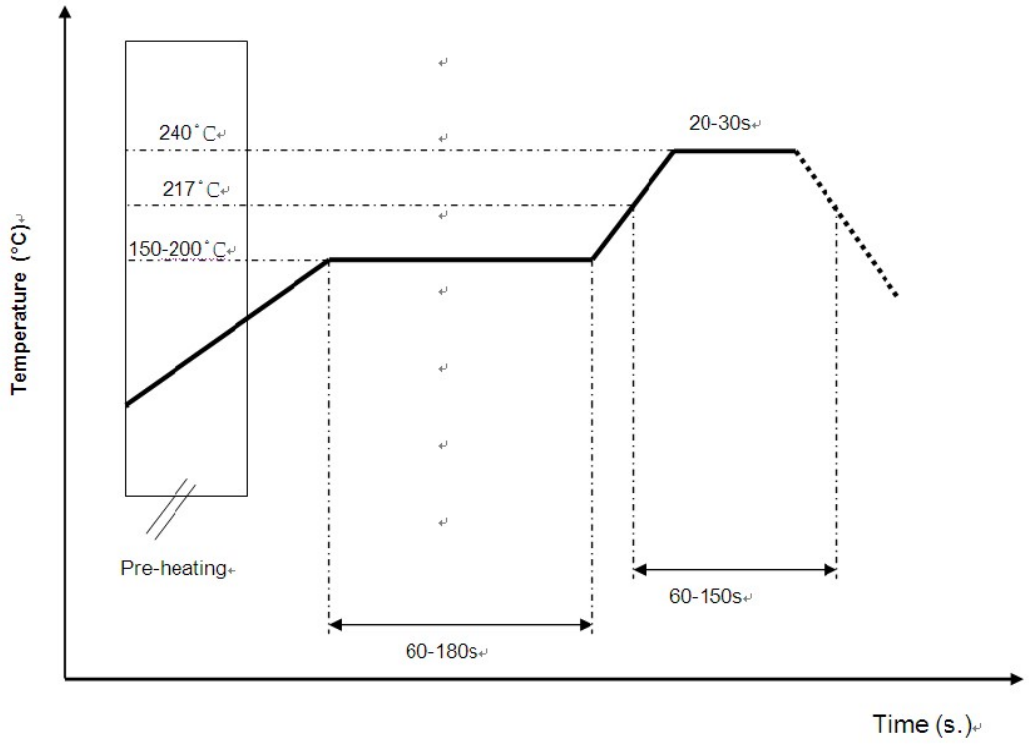
VII. Soldering conditions:

Typical Soldering Profile for Lead-free Process



*Recommended solder paste alloy: SAC305 (Sn96.5 /Ag3 /Cu0.5) Lead Free solder paste

VIII. Reminders for use of Unictron's ceramic chip antennas:

a) This chip antenna is made of ceramic materials which is relatively more rigid and brittle compared to circuit board materials. Furthermore, the length of this antenna is quite long. Bending of circuit board at the locations where chip antenna is mounted may cause the cracking of solder joints or antenna itself.

b) Punching/cutting of the break-off tab of PCB panel may cause severe bending of the circuit board which may result in cracking of solder joints or chip antenna itself. Therefore break-off tab shall be located away from the installation site of chip antenna.

c) Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

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IX. Operating & Storage conditions:

a) Operating

(1) Maximum Input Power**:** 2 W

(2) Operating Temperature**:** -40℃ to 85℃

(3) Relative Humidity**:** 10% to 70%

b) Storage (sealed)

(1) Storage Temperature**:** -5℃ to 40℃

(2) Relative Humidity**:** 20% to 70%

(3) Shelf Life**:** 1 year

c) Storage (unsealed)

Meet the criteria of J-STD-033 MSL2a

d) Storage (After mounted on customer's PCB with SMT process)

(1) Storage Temperature**:** -40℃ to 85℃

(2) Relative Humidity**:** 10% to 70%

X. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.

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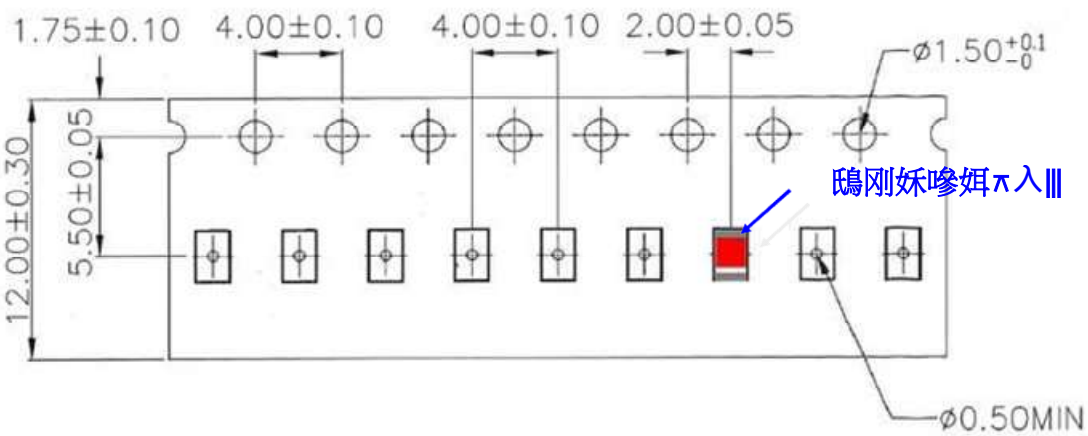
XI. Packing

(1) Unit Weight: 0.004±0.001(g) /pcs

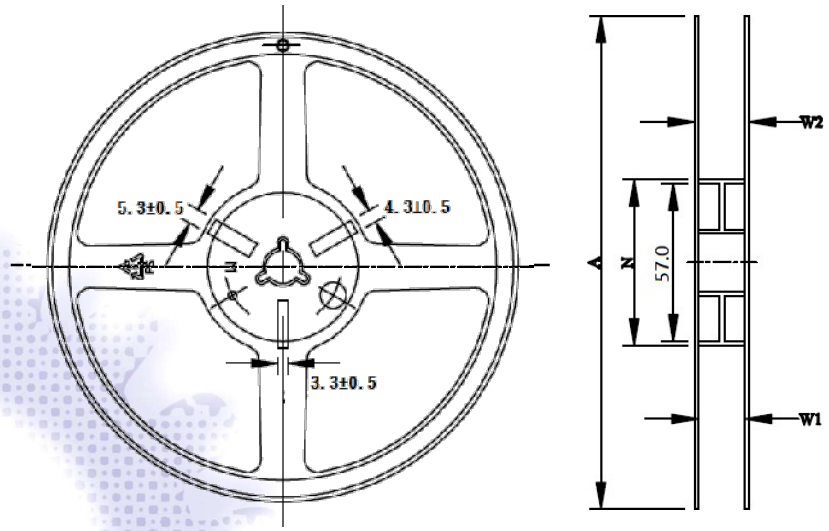
(2) Quantity/Reel: 5000 pcs/Reel

(3) Plastic tape: Black Conductive Polystyrene.

a. Tape Drawing (unit: mm)



b. Reel Drawing (unit: mm)



Feature	Specifications	Tolerances
A	178.0	±1.0
B	2.7	±0.5
C	13.3	±0.5
N	60.0	±0.5
W1	13.7	±0.5
W2	16.1	±0.5

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